

MP5007

5V, 1A- 5A Programmable Current Limit Switch

The Future of Analog IC Technology

DESCRIPTION

The MP5007 is a protection device designed to protect circuitry on the output (source) from transients on input (V_{CC}). It also protects V_{CC} from undesired shorts and transients coming from the source.

At start up, inrush current is limited by limiting the slew rate at the source. The slew rate is controlled by a small capacitor at the dv/dt pin. The dv/dt pin has an internal circuit that allows the customer to float this pin and still receives a 1.1ms ramp time at the source.

The max load at the output (source) is current limited. This is accomplished by utilizing a sense FET topology. The magnitude of the current limit is controlled by an external resistor from the I-Limit pin to the Source pin.

An internal charge pump drives the gate of the power device, allowing a very low on-resistance DMOS power FET of just $37m\Omega$.

The source is protected from the V_{cc} input being too low or too high. Under Voltage Lockout (UVLO) assures that V_{cc} is above the minimum operating threshold, before the power device is turned on. If V_{cc} goes above the high output threshold, the source voltage will be limited.

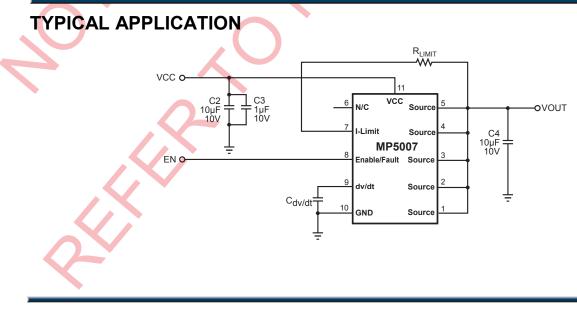
FEATURES

- Integrated 37mΩ Power FET
- Enable/Fault Pin
- Adjustable Slew Rate for Output Voltage
- Adjustable Current Limit
- Thermal Protection
- Over Voltage Limit
- Available in 3x3mm QFN10 Package

APPLICATIONS

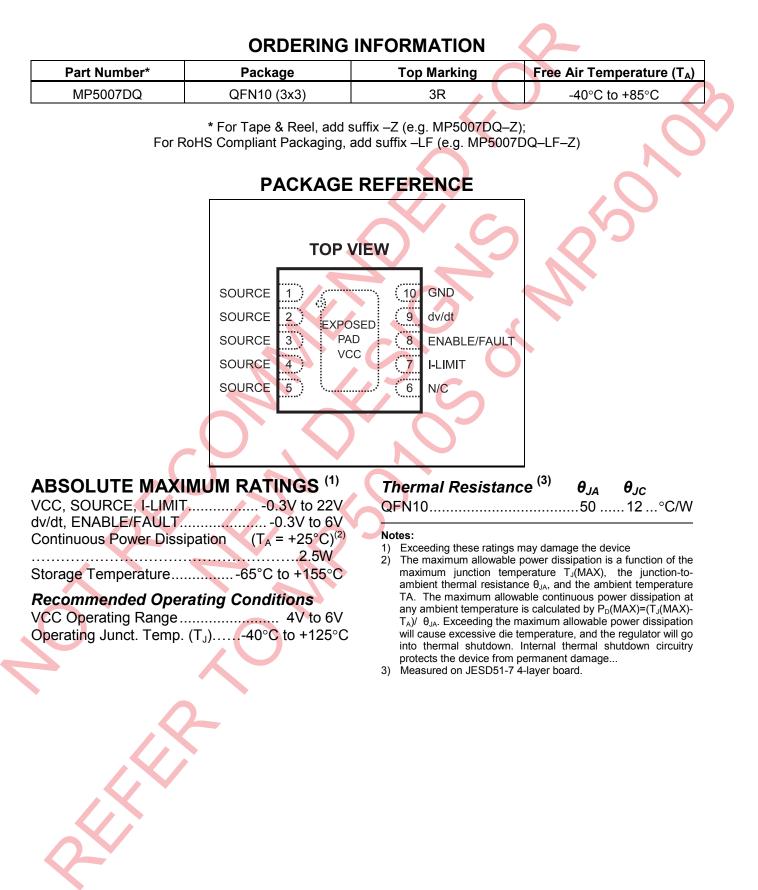
- Hot Swap
- PC Cards
- Cell Phones
- Laptops

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ELECTRICAL CHARACTERISTICS

 $V_{cc} = 5V$, $R_{LIMIT} = 22\Omega$, $C_{OUT} = 10\mu F$, $T_J = 25^{\circ}C$, unless otherwise noted.

Parameters	Symbol	Condition	Min	Тур	Max	Units
Power FET	·				•	
Delay Time	t _{DLY}	Enabling of chip to $I_D=100$ mA with a 12Ω resistive load		0.2		ms
ON Resistance	R_{DSon}	T _J =25°C T _J =80°C, Note 4		37 45	43	mΩ
Off State Output Voltage	V_{OFF}	V_{cc} =18V, Enable=0V, R _L =500Ω			120	mV
Continuous Current	I _D	0.5 in ² pad, T _J =25°C minimum copper, T _J =80°C	0	4.2 2.3		A
Thermal Latch						
Shutdown Temperature	T _{SD}	Note 4		175		°C
Under/Over Voltage Protection					T	1
Output Clamping Voltage	V _{CLAMP}	Overvoltage Protection V _{cc} =8V	5.95	6.65	7.35	V
Under Voltage Lockout	V _{UVLO}	Turn on, Voltage going high	3.2	3.6	4.0	V
Under Voltage Lockout (UVLO) Hysteresis	V _{HYST}			0.4		V
Current Limit						
Hold Current	I _{LIM-SS}	R_{LIMIT} =22Ω, 0Ω short resistance, Note 4	1.5	2.1	2.8	A
Trip Current	ILIM-OL	$R_{LIMIT}=22\Omega$, Note 4		3.3		Α
dv/dt Circuit						
Rise Time	Tr	Float dv/dt pin, Note 5	0.64	1.1	2.0	ms
Enable/Fault				•		•
Low Level Input Voltage	VIL	Output Disabled,			0.5	V
Intermediate Level Input Voltage	V _{I (INT)}	Thermal Fault, Output Disabled	0.82	1.6	2.0	V
High Level Input Voltage	V _{IH}	Output Enabled	2.5	1		V
High State Maximum Voltage	V _{I (MAX)}			4.8		V
Low Level Input Current (Sink)		V _{ENABLE} =0V		-28	-50	μA
Maximum Fanout for Fault Signal		Total number of chips that can be connected for simultaneous shutdown			3	Units
Maximum Voltage on Enable Pin	V _{MAX}	Note 6		1	VCC	V
Total Device	101/171	1	L	1		1
	I _{BIAS}	Device Operational		2	3	
Bias Current		Thermal Shutdown		1.3	-	mA
Minimum Operating Voltage for UVLO	V _{MIN}	Enable<0.5V			3.0	V

Notes:

4) Guaranteed by design.

5) Measured from 10% to 90%.

6) Maximum Input Voltage on Enable pin to be $\leq 6.0V$ if Vcc $\geq 6.0V$. Maximum Input Voltage on Enable pin to be Vcc if Vcc $\leq 6.0V$.





PIN FUNCTIONS

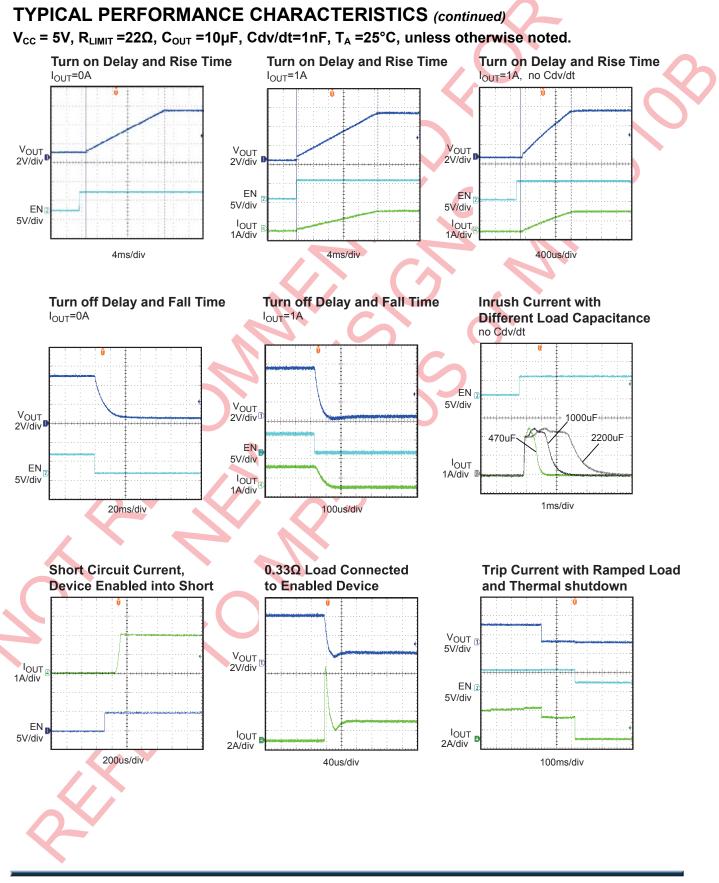
Pin #	Name	Description
1-5	SOURCE	This pin is the source of the internal power FET and the output terminal of the IC.
6	N/C	DO NOT CONNECT, The pin must be float.
7	I-Limit	A resistor between this pin and the Source pin sets the overload and short circuit current limit levels.
8	Enable/Fault	The Enable/Fault pin is a tri-state, bi-directional interface. It can be used to enable the output of the device by floating the pin, or disable the chip by pulling it to ground (using an open drain or open collector device). If a thermal fault occurs, the voltage on this pin will go to an intermediate state to signal a monitoring circuit that the device is in thermal shutdown.
9	dv/dt	The internal dv/dt circuit controls the slew rate of the output voltage at turn on. It has an internal capacitor that allows it to ramp up over the period of 1.1ms. An external capacitor can be added to this pin to increase the ramp time. If an additional time delay is not required, this pin should be left float.
10	GND	Negative Input Voltage to the Device. This is used as the internal reference for the IC.
11	VCC	Positive input voltage to the device (Exposed Pad).



TYPICAL PERFORMANCE CHARACTERISTICS $V_{cc} = 5V$, $R_{LIMIT} = 22\Omega$, $C_{out} = 10\mu$ F, Cdv/dt=1nF, $T_A = 25^{\circ}$ C, unless otherwise noted. Static Drain-Source On-State Supply Current, Output Supply Current, Output Enabled vs. Input Voltage **Disabled vs. Input Voltage** Resistance vs. Input Voltage V_{EN}=0V IOUT=0.5A 40 DRAIN-SOURCE ON-STATE RESISTANCE (mΩ) 2.35 1.21 1.2 SUPPLY CURRENT (mA) 38 2.3 CURRENT (mA) 1.19 1.18 2.25 36 1.17 34 2.2 1.16 SUPPLY 1.15 32 2.15 STATIC 1.14 30 2.1 1.13 4 4.25 4.54.75 5 5.25 5.5 5.75 6 4 4.5 5 5.5 6 6.5 4.5 5 5.5 7 4 6 6.5 INPUT VOLTAGE (V) INPUT VOLTAGE (V) INPUT VOLTAGE (V) Input to Output Voltage **Short Circuit Output** Trip Current vs. vs. Load Current Current vs. Input Voltage Input Voltage 2.2 3.45 120 INPUT TO OUTPUT VOLTAGE (mV) V_{CC=4}V 3.4 100 ₹ 2.1 V_{CC}=5V 3.35 € CURRENT 80 HOLD CURRENT 3.3 2 60 3.25 V_{CC}=6V TRIP 40 3.2 1.9 20 3.15 0 1.8 3.1 4.5 5 5.5 6 0.5 1.5 2 2.5 4.4 4.8 5.2 5.6 6 4 0 1 4 INPUT VOLTAGE (V) INPUT VOLTAGE (V) LOAD CURRENT (A) **Trip Current & Hold Current Limit Response** vs. Peak Current Current vs. RLIMIT no C_{OUT} € 3.5 18 CURRENT LIMIT RESPONSE TIME (us) CURRENT & HOLD CURRENT Trip Current 3 15 2.5 12 2 9 Hold Current 1.5 6 1 3 0.5 TRIP (0 0 12 20 20 30 40 50 60 70 80 90 100 8 16 PEAK CURRENT (A) $R_{LIMIT}(\Omega)$

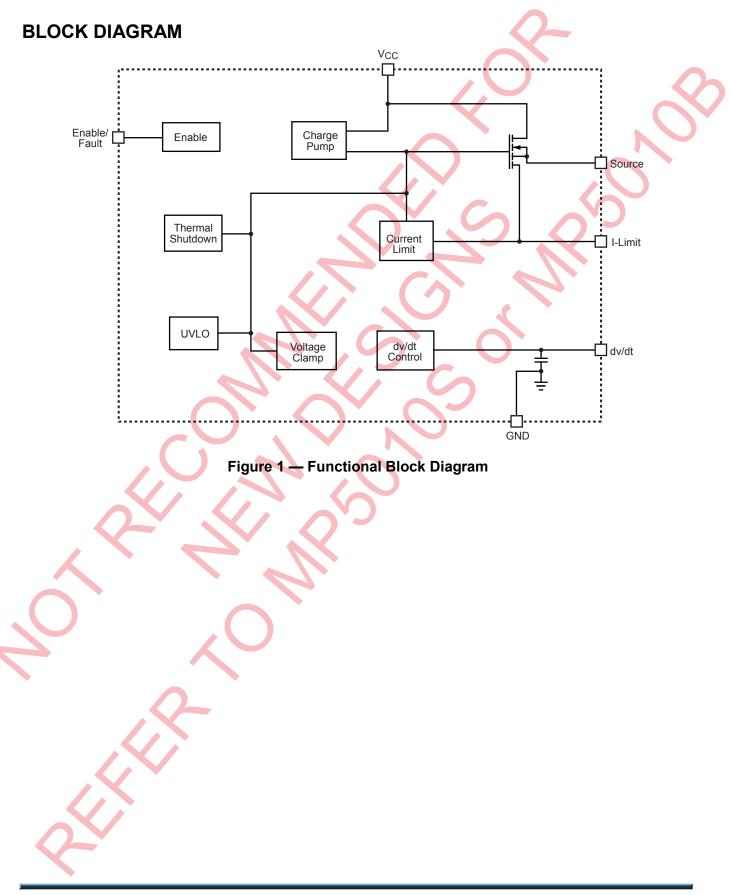
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DETAILED DESCRIPTION

Current Limit

The desired current limit is a function of the external current limit resistor.

Table1 — Current Limit vs. Current Limit Resistor (V_{cc}=5V)

Current Limit Resistor(Ω)	22	50	75	100
Trip Current(A)	3.3	2.4	2.1	2
Hold Current(A)	2.1	1	0.7	0.6

When the part is active, if load reaches trip current (minimum threshold current triggering overcurrent protection) or a short is present, the part switches into to a constant-current (hold current) mode. Part will be shutdown only if the overcurrent condition stays long enough to trigger thermal protection.

However, when the part is powered up by V_{cc} or EN, the load current should be smaller than hold current. Otherwise, the part can't be fully turned on.

In a typical application using a current limit resistor of 22Ω , the trip current will be 3.3A and the hold current will be 2.1A. If the device is in its normal operating state and passing 2.0A it will need to dissipate only 148mW with the very low on resistance of $37m\Omega$. For the package dissipation of 50°C/Watt, the temperature rise will only be + 7.4°C. Combined with a 25°C ambient, this is only 32.4°C total package temperature.

During a short circuit condition, the device has 5V across it and the hold current clamps at 2.1A and therefore must dissipate 10.5W. At 50°C/watt, if uncontrolled, the temperature would rise above the MP5007 thermal protection (+175°C) and the device will be shutdown.

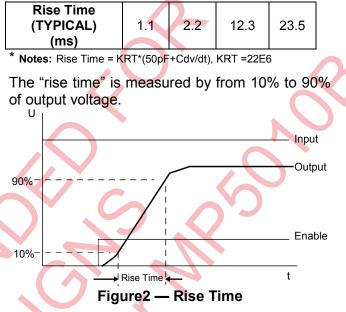
Proper heat sink must be used if the device is intended to supply the hold current and not shutdown. Without a heat sink, hold current should be maintained below 600mA at +25°C and below 360mA at +85°C to prevent the device from activating the thermal shutdown feature.

Rise Time

The rise time is a function of the capacitor (Cdv/dt) on the dv/dt pin.

Table2 — Rise Time* vs. Cdv/dt

Cdv/dt none 50pF 500pF 1nF



Fault and Enable Pin

The Enable/Fault Pin is a Bi-Directional three levels I/O with a weak pull up current (28uA typical). The three levels are low, mid and high. It functions to enable/disable the part and to indicate Fault information.

Enable pin as an input:

- 1. Low and mid disable the part.
- 2. Low, in addition to disabling the part, clears the fault flag.
- 3. High enables the part (if the fault flag is clear).

Enable pin as an output:

- 1. The pull up current may (if not over ridden) allow a "wired nor" pull up to enable the part.
- 2. An under voltage will cause a low on the enable pin, and will clear the fault flag.
- 3. A thermal fault will cause a mid level on the enable pin, and will set the fault flag.

The Enable/Fault line must be above the mid level for the output to be turned on.

The fault flag is a internal flip-flop that can be set or reset under various conditions:

- 1. Thermal Shutdown: set fault flag
- 2. Under Voltage: reset fault flag
- 3. Low voltage on Enable/Fault pin: reset fault flag
- 4. Mid voltage on Enable/Fault pin: no effect

Under a fault, the Enable/Fault pin is driven to the mid level.

There are 4 types of faults, and each fault has a direct and indirect effect on the Enable/Fault pin and the internal fault flag. In a typical application there are one or more of the MP5007 chips in a system. The Enable/Fault lines will typically be connected together.

Fault description	Internal action	Effect on Fault Pin	Effect on Flag	Effect on secondary Part
Short/over current	Limit current	none	none	none
Under Voltage	Output is turned off	Internally drives Enable/Fault pin to Logic low	Flag is reset	Secondary part output is disabled, and fault flag is reset.
Over Voltage	Limit output voltage	None	None	None
Thermal Shutdown	Shutdown part. The part is latched off until a UVLO or externally driven to ground.	Internally drives Enable/Fault pin to mid level	Flag is Set	Secondary part output is disabled.

Table3 — Fault Function Influence in Application

Under Voltage Lock Out Operation

If the supply (input) is below the UVLO threshold, the output is disabled, and the fault line is driven low.

When the supply goes above the UVLO threshold, the output is enabled and the fault line is released. When the fault line is released, EN will be pulled high by a 28uA current source. No external pull up resistor is required. In addition, the pull up voltage is limited to 5 volts.

Thermal Protection

When thermal protection is triggered, the output is disabled and the fault line is driven to the mid level. The thermal fault condition is latched (meaning the fault flag is set), and the part will remain latched off until the fault (enable) line is brought low. Cycling the power below the UVLO threshold will also reset the fault flag.



PCB Layout

PCB layout is very important to achieve stable operation. Please follow these guidelines and take below figure for reference.

Place Rlimit close to I_limit pin, Cdv/dt close to

dv/dt pin and input cap close to Vcc. Keep the N/C pin float. Put vias in thermal pad and ensure enough copper area near Vcc and source to achieve better thermal performance.

